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AUG 13 2005  
PATENT & TRADEMARK

Docket No.: ASMGEN.003APC

August 10, 2005

Page 1 of 1

Please Direct All Correspondence to Customer Number **20995**

**TRANSMITTAL LETTER**  
**INFORMATION DISCLOSURE STATEMENT**

Applicant : Park et al.  
App. No : 10/500,494  
Filed : December 28, 2002  
For : METHOD OF FORMING COPPER  
INTERCONNECTIONS FOR  
SEMICONDUCTOR INTEGRATED  
CIRCUITS ON A SUBSTRATE  
Examiner : Thanh V. Pham  
Art Unit : 2823

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

August 10, 2005

(Date)

Adeel S. Akhtar, Reg. No. 41,394

**Mail Stop Amendment**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing in the above-identified application are:

- (X) A Preliminary Amendment in 3 page.
- (X) Statement Under 37 CFR §3.73(b) and Change of Correspondence Address and copy of General Power of Attorney.
- (X) The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment, to Account No. 11-1410.
- (X) Return prepaid postcard.

Adeel S. Akhtar  
Adeel S. Akhtar  
Registration No. 41,394  
Attorney of Record  
Customer No. 20,995  
(415) 954-4114